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March 2016

FGY40T120SMD — 1200 V, 40 A Field Stop Trench IGBT

FGY40T120SMD 1200 V, 40 A Field Stop Trench IGBT

Features

- FS Trench Technology, Positive Temperature Coefficient
- · High Speed Switching
- + Low Saturation Voltage: V_{CE(sat)} =1.8 V @ I_C = 40 A
- 100% of the Parts tested for I_{LM}(1)
- High Input Impedance
- RoHS Compliant

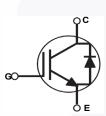
General Description

Using innovative field stop trench IGBT technology, Fairchild's new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.

Applications

• Solar Inverter, Welder, UPS & PFC applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Description | | FGY40T120SMD | Unit |
|---------------------|--|---------------------------------------|--------------|------|
| V _{CES} | Collector to Emitter Voltage | | 1200 | V |
| V _{GES} | Gate to Emitter Voltage | | ±25 | V |
| | Transient Gate to Emitter Voltage | | ±30 | V |
| I _C | Collector Current | @ T _C = 25°C | 80 | А |
| | Collector Current | @ T _C = 100°C | 40 | A |
| I _{LM} (1) | Clamped Inductive Load Current @ $T_{C} = 25^{\circ}C$ | | 160 | А |
| I _{CM} (2) | Pulsed Collector Current | 160 | А | |
| I _F | Diode Continuous Forward Current | @ T _C = 25°C | 80 | А |
| | Diode Continuous Forward Current | @ T _C = 100°C | 40 | A |
| I _{FM} | Diode Maximum Forward Current | | 240 | А |
| P _D | Maximum Power Dissipation | @ T _C = 25°C | 882 | W |
| | Maximum Power Dissipation | @ T _C = 100 ^o C | 441 | W |
| TJ | Operating Junction Temperature | | -55 to +175 | °C |
| T _{stg} | Storage Temperature Range | -55 to +175 | °C | |
| TL | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds | 300 | °C | |

Thermal Characteristics

| Symbol | Parameter | Тур. | Max. | Unit |
|-------------------------|---|------|------|------|
| R _{θJC} (IGBT) | Thermal Resistance, Junction to Case | | 0.17 | °C/W |
| $R_{\theta JC}$ (Diode) | Thermal Resistance, Junction to Case | | 0.55 | °C/W |
| $R_{	extsf{	heta}JA}$ | Thermal Resistance, Junction to Ambient | | 40 | °C/W |

Notes:

1. Vcc = 600 V,V_{GE} = 15 V, I_C = 160 A, R_G = 10 $\odot,~$ Inductive Load 2. Limited by Tjmax

1

| Device Marking Device | | Package | Reel Size | Tape Width | | Quantity | | | |
|-----------------------|---------------------------|---|--|---|------|----------|------|------|--|
| FGY40T1 | FGY40T120SMD FGY40T120SMD | | | - | | - | | 30 | |
| Electric | al Char | acteristics of the | e IGBT _{Tc} = 25°C | unless otherwise noted | | | | | |
| Symbol | | Parameter | Test Co | onditions | Min. | Тур. | Max. | Unit | |
| Off Charac | toristics | | | | | | | | |
| BV _{CES} | | o Emitter Breakdown Volta | age V _{GE} = 0 V, I _C = | 250 uA | 1200 | - | - | V | |
| I _{CES} | | Cut-Off Current | $V_{CE} = V_{CES}, V_{CES}$ | | - | - | 250 | uA | |
| I _{GES} | | age Current | | | - | _ | ±400 | nA | |
| GES | O E Eduk | | GE GES, | $V_{GE} = V_{GES}, V_{CE} = 0 V$ | | | 1100 | 10.0 | |
| On Charac | teristics | | | | | | | | |
| V _{GE(th)} | G-E Three | shold Voltage | I _C = 40 mA, V _C | _E = V _{GE} | 4.9 | 6.2 | 7.5 | V | |
| | | | $T_{\rm C} = 25^{\rm o}{\rm C}$ | $I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V}$ $T_{C} = 25^{\circ}\text{C}$ | | 1.8 | 2.4 | V | |
| V _{CE(sat)} | Collector 1 | o Emitter Saturation Volta | ge $I_{C} = 40 \text{ A}, V_{GE}$ $T_{C} = 175^{\circ}\text{C}$ | $I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$ | | 2.0 | - | V | |
| Dynamic C | haracteris | tics | | | | | | | |
| C _{ies} | Input Cap | Input Capacitance V _{CE} = 30 V _{CE} = 10 MHz | | | | 4300 | - | pF | |
| C _{oes} | Output Ca | | | v _{GE} = 0 v, | - | 180 | - | pF | |
| C _{res} | Reverse 1 | ransfer Capacitance | | | - | 100 | - | pF | |
| Switching | Characcte | ristics | | | | | | | |
| t _{d(on)} | Turn-On E | elay Time | | | - | 40 | - | ns | |
| t _r | Rise Time | | | | - | 47 | - | ns | |
| t _{d(off)} | Turn-Off D | elay Time | V _{CC} = 600 V, I ₀ | ₂ = 40 A, | - | 475 | - | ns | |
| t _f | Fall Time | | R _G = 10 Ω, V _G | R_{G} = 10 Ω , V_{GE} = 15 V, | | 10 | - | ns | |
| Eon | Turn-On S | Switching Loss | Inductive Load | , 1 _C = 25°C | - | 2.7 | - | mJ | |
| E _{off} | Turn-Off S | Switching Loss | | | - | 1.1 | - | mJ | |
| E _{ts} | Total Swite | ching Loss | | | - | 3.8 | - | mJ | |
| t _{d(on)} | Turn-On E | Delay Time | | | - | 40 | - | ns | |
| t _r | Rise Time | | | | - | 55 | - | ns | |
| t _{d(off)} | Turn-Off D | Delay Time | V _{CC} = 600 V, I ₀ | _c = 40 A, | - | 520 | - | ns | |
| t _f | Fall Time | | R _G = 10 Ω, V _G | _E = 15 V, | - | 50 | - | ns | |
| Eon | Turn-On S | Switching Loss | Inductive Load | $1_{\rm C} = 175^{\circ}{\rm C}$ | - | 3.4 | - | mJ | |
| E _{off} | Turn-Off S | Switching Loss | | | - | 2.5 | - | mJ | |
| E _{ts} | Total Swite | ching Loss | | | - | 5.9 | - | mJ | |
| Qg | Total Gate | Charge | | | - | 370 | - | nC | |
| Q _{ge} | Gate to Er | mitter Charge | $V_{CE} = 600 \text{ V}, \text{ I}_{C}$ | _c = 40 A, | - | 23 | - | nC | |
| Q _{gc} | Gate to C | ollector Charge | V _{GE} = 15 V | - | - | 210 | - | nC | |

2

| FGY40T120SMD |
|--------------------------|
| — 1200 V, 4 |
| 40 A Field S |
| A Field Stop Trench IGBT |
| IGBT |

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|------------------|-------------------------------|--|------|------|------|------|
| V _{FM} | Diode Forward Voltage | I _F = 40 A, T _C = 25°C | - | 3.8 | 4.8 | V |
| | | I _F = 40 A, T _C = 175 ^o C | - | 2.7 | - | V |
| t _{rr} | Diode Reverse Recovery Time | V _R = 600 V, I _F = 40 A, | - | 65 | - | ns |
| Q _{rr} | Diode Reverse Recovery Charge | $di_{F}/dt = 200 \text{ A/us}, T_{C} = 25^{\circ}C$ | - | 234 | - | nC |
| E _{rec} | Reverse Recovery Energy | V _R = 600 V, I _F = 40 A, | - | 97 | - | uJ |
| t _{rr} | Diode Reverse Recovery Time | $di_{F}/dt = 200 \text{ A/us}, T_{C} = 175^{\circ}C$ | - | 200 | - | ns |
| Q _{rr} | Diode Reverse Recovery Charge | | - | 1800 | - | nC |

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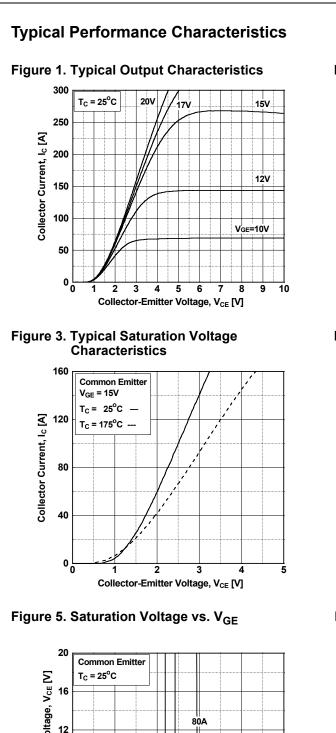
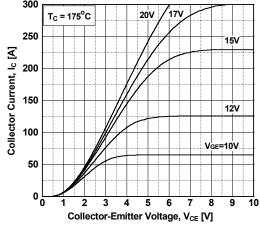
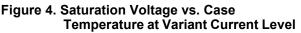
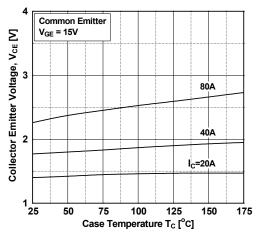


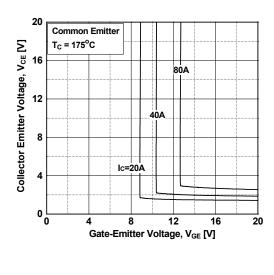
Figure 2. Typical Output Characteristics

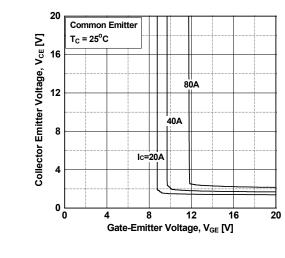












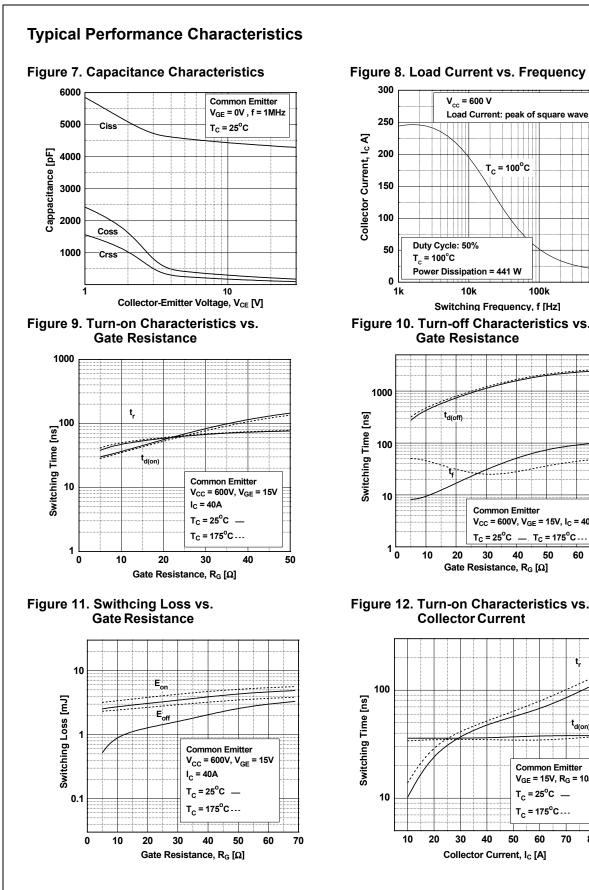


Figure 8. Load Current vs. Frequency

10k

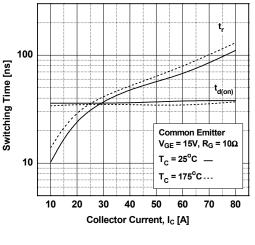
T_C = 100^oC

100k

1M

Switching Frequency, f [Hz] Figure 10. Turn-off Characteristics vs. **Gate Resistance** t_{d(off)} Common Emitter V_{CC} = 600V, V_{GE} = 15V, I_C = 40A $T_{C} = 25^{\circ}C$ ____ $T_{C} = 175^{\circ}C$... 20 30 40 50 60 70 Gate Resistance, R_G [Ω]





Typical Performance Characteristics

Figure 13. Turn-off Characteristics vs. Collector Current

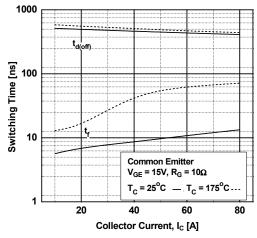
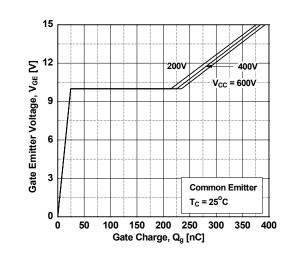
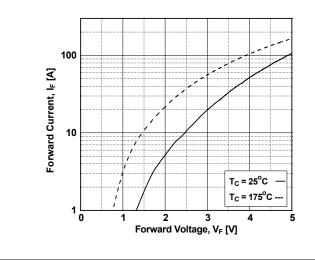


Figure 15. Gate Charge Characteristics







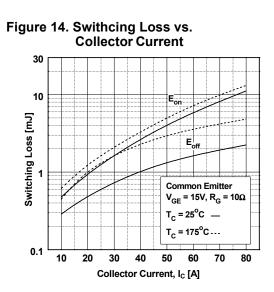


Figure 16. SOA Characteristics

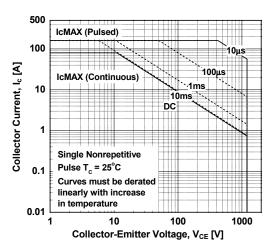
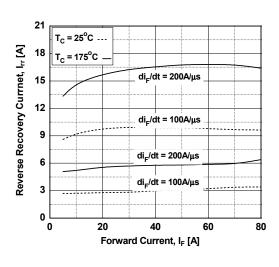
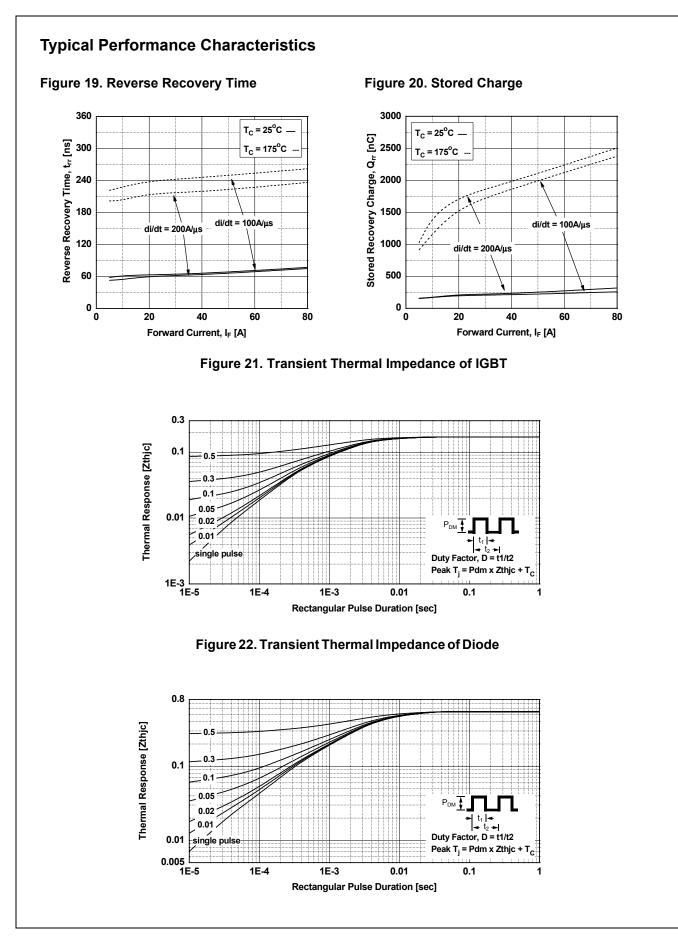
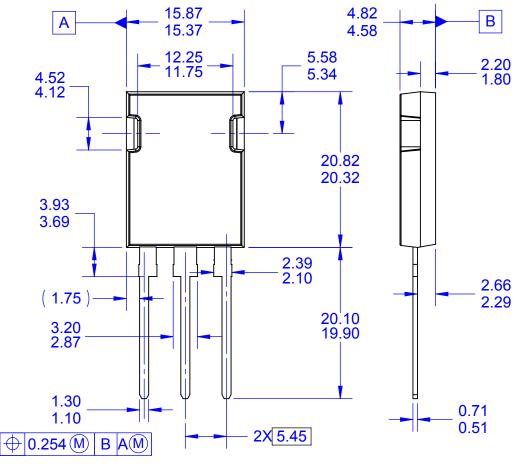


Figure 18. Reverse Recovery Current







13.80 13.40 1.35 0.51 17.03 16.63 16.63

FRONT VIEW

SIDE VIEW

BOTTOM VIEW

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